## NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE025N30G uses advanced trench technology and design to provide excellent  $R_{\text{DS(ON)}}$  with low gate charge. It can be used in a wide variety of applications.

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

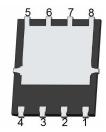
100% UIS TESTED! 100% ΔVds TESTED!

#### **General Features**

- $V_{DS}$  =30V, $I_D$  =115A  $R_{DS(ON)}$ =2.2mΩ (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =3.6mΩ (typical) @  $V_{GS}$ =4.5V
- High density cell design for ultra low Rdson
- Very low on-resistance R<sub>DS(on)</sub>
- Good stability and uniformity with high E<sub>AS</sub>
- 150 °C operating temperature
- Pb-free lead plating

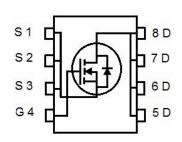
#### **DFN 5X6**





**Top View** 

**Bottom View** 



**Schematic Diagram** 

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
025N30G	NCE025N30G	DFN 5x6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	115	Α
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100°C)	81	Α
Pulsed Drain Current <sup>(Note 1)</sup>	I <sub>DM</sub>	460	Α
Maximum Power Dissipation	P <sub>D</sub>	70	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	Eas	384	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	Rejc	1.79	°C/W



## Electrical Characteristics (TC=25°Cunless otherwise noted)

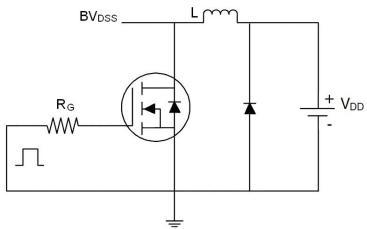
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1	1.5	2.5	V
Dunin Course On Ctata Desistance		V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	2.2	2.9	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	3.6	5.2	
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =20A	-	50	-	S
Dynamic Characteristics (Note4)	,		•			
Input Capacitance	Clss	\\ 45\\\\ 0\\	-	3120	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V,	-	445	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	421	-	PF
Switching Characteristics (Note 4)				,		
Turn-on Delay Time	t <sub>d(on)</sub>		-	11	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =15V, $I_{D}$ =20A $V_{GS}$ =10V, $R_{GEN}$ =6 $\Omega$	-	16	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	38	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	7	-	nS
Total Gate Charge	Qg	\/ 45\/\ 00A	-	71	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	10.4	-	nC
Gate-Drain Charge	$Q_{\mathrm{gd}}$	V <sub>GS</sub> -10V	-	16.2	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	115	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, I <sub>F</sub> = 20A	-	30	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	60	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negl	igible (turi	n-on is do	minated b	y LS+LD)

#### Notes:

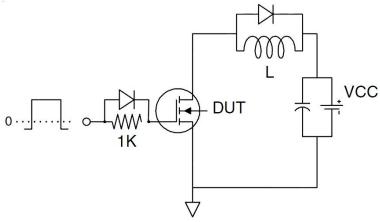
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V<sub>DD</sub>=15V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$

## **Test Circuit**

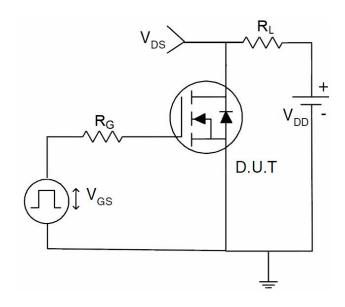
## 1) E<sub>AS</sub> Test Circuits



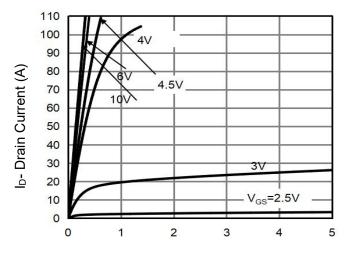
## 2) Gate Charge Test Circuit



## 3) Switch Time Test Circuit

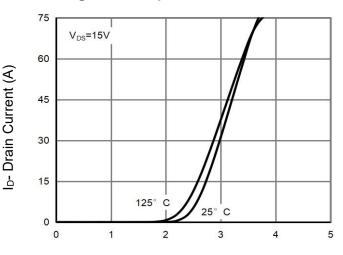


## Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

**Figure 1 Output Characteristics** 



Vgs Gate-Source Voltage (V)

**Figure 2 Transfer Characteristics** 

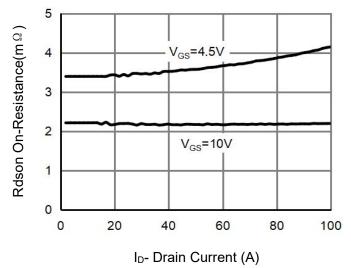


Figure 3 Rdson- Drain Current

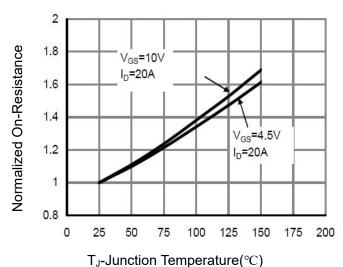


Figure 4 Rdson-JunctionTemperature

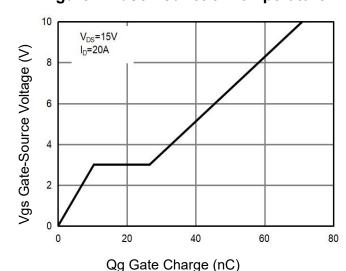
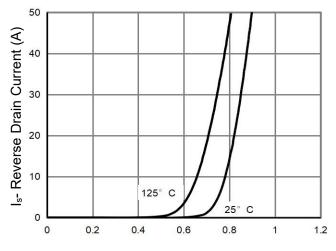


Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



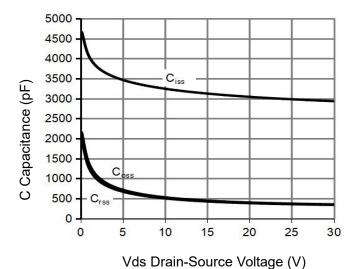


Figure 7 Capacitance vs Vds

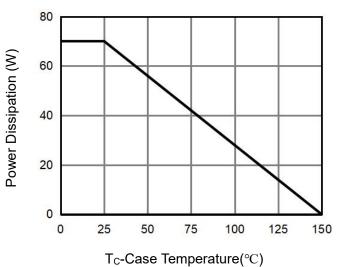


Figure 9 Power De-rating

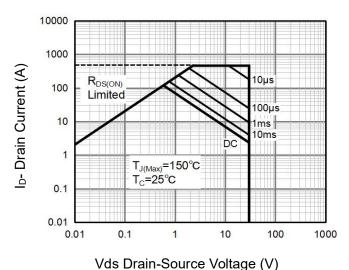
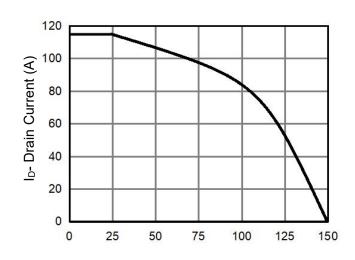
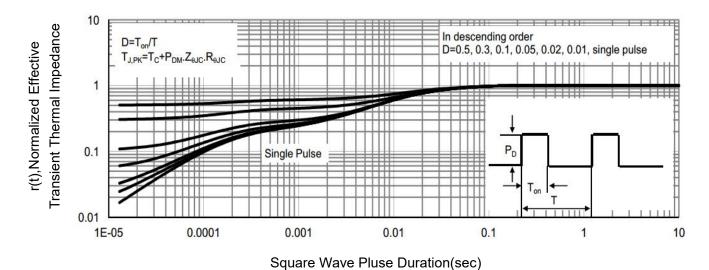


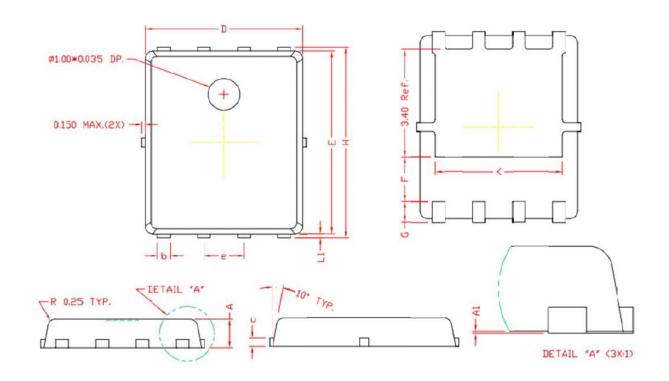
Figure 8 Safe Operation Area





**Figure 11 Normalized Maximum Transient Thermal Impedance** 

## **DFN5X6-8L Package Information**



## COMMON DIMENSIONS

# (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX	
A	0.80	0.90	1.00	
A1	0.00	0.03	0.05	
b	0.35	0.42	0.49	
С	0. 254 REF.			
D	4.90	5.00	5. 10	
F	1.40 REF.			
Е	5. 70	5.80	5. 90	
е	1. 27 BSC.			
Н	5. 95	6. 08	6. 20	
L1	0.10	0. 14	0. 18	
G	0.60 REF.			
K	4.00 REF.			



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